

INTERCONNECTS

SERIES 850 & 851 • .050" GRID SOLDER CUP HEADERS AND SOCKETS • SINGLE ROW STRIPS

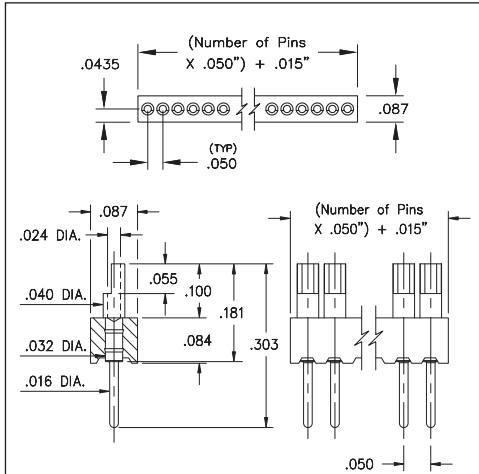


FIG. 1

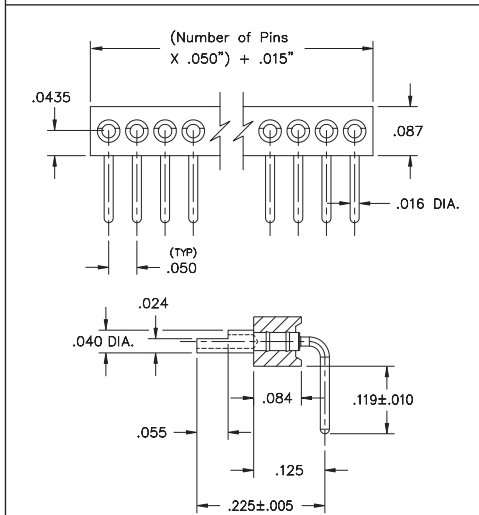


FIG. 2

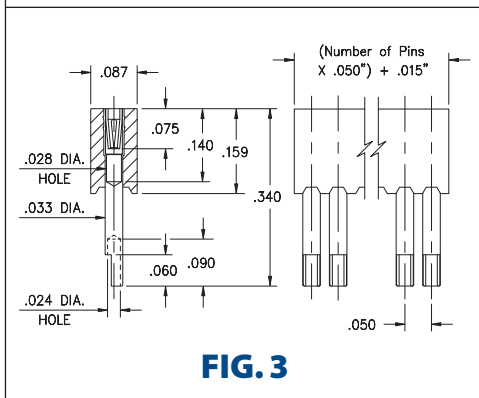
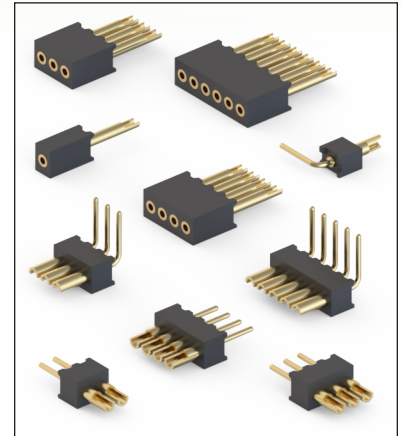


FIG. 3

- Solder cups are pre-aligned and accept up to 26 AWG wire
- Series 850 headers use MM #3050-0 pins. See page 244 for details
- Series 851 sockets use MM #1157-0 receptacles that accept pin diameters from .015"-.020". See page 160 for details
- Receptacles use Hi-Rel, 3-finger BeCu #11 contact rated at 3 amps. See page 251 for details
- Insulators are high temperature thermoplastic, suitable for all soldering operations



ORDERING INFORMATION







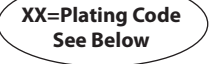
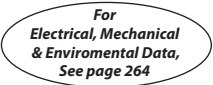



FIG. 1	Series 850...003	Single Row Solder Cup / Solder Tail				
	850-XX-0_-10-003000		Specify number of pins → 01-50			
FIG. 2	Series 850...003	Single Row Right Angle Solder Cup				
	850-XX-0_-20-003000		Specify number of pins → 01-50			
  						
SPECIFY PLATING CODE XX=			10 			
Pin Plating 			10 μ" Au			

FIG. 3	Series 851...003	Single Row Solder Cup Socket				
	851-XX-_-10-003000		Specify number of pins → 01-50			
  						
SPECIFY PLATING CODE XX=			13 			
Sleeve (Pin) 			10 μ" Au			
Contact (Clip) 			30 μ" Au			

